United States Patent and Trademark

|  | HDP Docket No. 9319S-001027                                    |
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| Terunao HANAOKA  | Name: Seiko Epson Corporation                                  |
|  | Internal Address:  |
| Execution Date(s) March 8, 2005 Additional name of conveying party(les) attached? ☐ Yes ☒ No | £-   |
| 3. Nature of conveyance:   | Street Address: 4-1 Nishi-shinjuku 2-chome                     |
| ⊠ Assignment □ Merger  |  |
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| ☐ Government Interest Assignment   | State: Tokyo   |
| ☐ Executive Order 9424, Confirmatory License   | Country: Japan Zip: 163-0811                                   |
| ☐ Other  |  |
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| 4. Application number(s) or patent number(s):  |  |
| A. Patent Application No.(s)   | B. Patent No.(s)   |
|  |  |
| Additional numbers atta  | ·<br>ached? ☐ Yes ☒ No   |
| Name and address of party to whom correspondence concerning this document should be mailed:  | 6. Total number of applications and patents involved: 1        |
| Name: G. Gregory Schivley  | 7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00                  |
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|  | ☐ None required (government interest not affecting title)      |
| City: Bloomfield Hills   |  |
| State <u>; Ml</u> Zip: <u>48303</u>  | 8. Payment Information   |
| Phone Number : 248-641-1600  | a. Credit Card Last 4 Numbers<br>Expiration Date               |
| Fax Number: 248-641-0270   | b. Deposit Account Number 50-3213                              |
| Email Address: <u>bewade@hdp.com</u>   | Authorized User Name Epson R&D                                 |

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March 14, 2005 Date

## Seiko Epson Ref. No.: J0108508US01

## 譲渡証(Translation/日本語訳)

下記に署名した私/私達、

## 花岡 輝直 は、

ある発明を創出し、これについて合衆国特許出版は

| ○ ここに私/私達により署名され,    |
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その発明は

半導体装置及びその製造方法、回路基板並びに電子機器

という名称である。 そして、ここにその受領を認める対価で: 私/私達は、当該発明/出願について、合衆国とその属領及び 全ての外国に於ける全面的かつ独占的な権利;合衆国とその属 領及び全ての外國に於いて発行される特許証に関わる全ての 権利、所有権、利益; 一部継続出願、継続出願、分割出願、 差替え出願、再発行出顧、特許期間延長等、合衆国とその属領 及び全ての外国に於いて既に出願されたか若しくは今後出願 される特許に関わる全ての権利;そして、国際条約、同盟、契 約、法令、協定(将来制定されるものを含む)に基づく全ての 優先権を伴う一切の権利;を、日本国東京都新宿区西新宿2丁 目4番1号に住所を有するセイコーエブソン株式会社、その後 継者、設受人及び法定代理人に対して、死却、譲渡、移転する ものとする。

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## Assignment

For good and valuable consideration, the receipt of which is hereby acknowledged, I/WE, the undersigned.

#### Terunao HANAOKA,

who have created a certain invention for which an application for United States Letters Patent

| $\boxtimes$ | executed by ME/US on even date herewith,       |
|-------------|--|
|             | executed by ME/US on, (respectively).          |
|             | filed on and assigned Serial No,               |
|             | filed as International Application No filed on |
|             |  |

and entitled:

# SEMICONDUCTOR DEVICE, MANUFACTURING METHOD THEREOF, CIRCUIT BOARD, AND ELECTRONIC APPLIANCE

Do hereby sell, assign and transfer to Seiko Epson Corporation, a corporation of Japan, having a place of business at 4-1. Nishi-shinjuku 2-chome, Shinjuku-ku, Tokyo, Japan, its successors, assigns, and legal representatives, the full and exclusive right to said invention and said application and to any and all inventions described in said application for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States, its territorial possessions and all foreign countries; and in and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filed in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the international conventions, unions, agreements, acts, and treaties, including all future conventions, unions, agreements, acta, and treaties:

Agree that Seiko Epson Corporation, hereinafter referred to as Assignee, may apply for and receive Letters Patent for said invention and said inventions, hereinafter referred to as said invention, in its own name, in the United States, its territorial possessions, and all foreign countries; and that, when requested to carry out in good faith the intent and purpose of this assignment, at the expense of said Assignee, its successors, assigns and legal representatives, the undersigned will execute continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, execute all rightful oaths, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate to said Assignee, its successors, assigns or legal representatives all facts known to the undersigned relating to said invention and the history thereof, and generally do everything possible which said Assignee, its successors, assigns, or legal representatives shall consider desirable for aiding in securing maintaining and enforcing proper patent protection for said invention and for vesting title to said invention and all applications for patents on said invention in said Assignee, its successors, assigns, or legal representatives; and

### Seiko Epson Ref. No.: J0108508US01

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さらに、下記に署名した私/私達はこの譲渡暦は英語の部分の 表現によってのみ解釈されることに同意する。

上記を証明するため、私/私達は下記日付で署名する。

Covenant with said Assignee, its successors, assigns, or legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

L/WE, the undersigned do further agree that this Assignment is to be construed solely according to the terms of the English language portions thereof.

IN TESTIMONY WHEREOF I/WE have hereunto set MY/OUR signature seal on the date indicated below.

| 唯一または第一発明者名<br>************************************ |           | Full name of sole or first inventor        |  |  |
|---|-----------|--|--|--|
| 花岡 輝直   |           | Terunao HANAOKA                            |  |  |
| 発明者の署名  | <b>日付</b> | Inventor's signature                       | Date                                       |  |
| 花周 輝直   | 2005年3月8日 | Terumo HANADKA                             | March. 8, 2005                             |  |
| 第二共同発明者(いる場合)                                       |           | Full name of second joint inventor, if ar  | Full name of second joint inventor, if any |  |
| 第二共同発明者の答名  | 日付        | Second Inventor's signature                | Date                                       |  |
| 第三共同発明者 (いる場合)                                      |           | Full name of third joint inventor, if any  | <del></del>                                |  |
| 第三共同発明者の署名  | 日付        | Third Inventor's signature                 | Date                                       |  |
|   | #;"       | · 類:                                       |  |  |
| 第四共同発明者 (いる場合)                                      |           | Full name of fourth joint inventor, if any | ,  |  |
| 第四共同発明者の岩名  | 日付        | Fourth Inventor's signature                | Date                                       |  |
| 第五共同発明者(いる場合)                                       |           | Full name of fifth joint inventor, if any  |  |  |
| 第五共同発明者の署名  | 日付        | Fifth Inventor's signature                 | Date                                       |  |
| 第六共国発明者(いる場合)                                       |           | Full name of sixth joint inventor, if any  | ·  |  |
| 第六共闘発明者の署名  | 日付        | Sixth Inventor's signature                 | Date                                       |  |
| 第七共同発明者(いる場合)                                       | :<br>     | Full name of seventh joint inventor, if a  | ny   |  |
| 第七共同発明者の署名  | 日付        | Seventh Inventor's signature               | Date                                       |  |
| 第八共同発明者(いる場合)                                       |           | Full name of eighth joint inventor, if any |  |  |
| 第八共同発明者の署名  | 日付        | Eighth Inventor's signature                | Date                                       |  |

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